High Voltage Thick Film Chip Resistors

Version. C

FEATURE



- Higher Max. Working Voltage than general purpose series resistors.
- High reliability and stability
- RoHS complaint
- Compatible with reflow and wave soldering
- Applications:
 - Adapters
 - Back-light circuit
 - Camera
 - Industrial Equipment
 - etc.

MANUFACTURER PART NO.

For example: VR1206J100KT5G00 - VR1206 $\pm 5\%$ 100K Ω T/R-5000

Series	Size	Tol.	Nominal Resistance Value	PKG	SPQ	Feature	TCR
2 codes	4 codes	1 code	2~5 codes	1 code	1 code	1 code	2 codes
VR	1206	J	100K	Т	5	G	00
High Voltage Thick Film Chip Resistors		F=±1% J=±5%	36K ⁰ =36KΩ 49K9=49.9KΩ 4M7 ² =4.7MΩ	T=T/R ³	4=4K 5=5K	G=Std. S=P.C. ⁴⁰	00=Refer to RELIABILITY.

Note: ① $K=Kilo, 10^3, K\Omega$

③ T/R=Taping in Reel package type

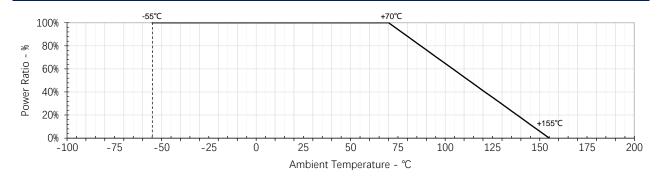
② M=Mega, 10^6 , M Ω

4 P.C.=Personal and Customized.

CHARACTERISTICS

Туре	Rated Power	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Tolerance	Value Range	Operating Temp.
VR0603	1/10W	350V	500V	500V	±1, ±5%	36ΚΩ-22ΜΩ	
VR0805	1/8W	400V	800V	800V	±1, ±5%	100ΚΩ-22ΜΩ]
VR1206	1/4W	500V	1000V	1000V	±1, ±5%	100ΚΩ-22ΜΩ	-55∼+155℃
VR1210	1/2W	800V	1500V	1000V	±1, ±5%	50ΚΩ-22ΜΩ	-33-4133 C
VR2010	3/4W	2000V	3000V	1000V	±1, ±5%	50ΚΩ-22ΜΩ	
VR2512	1W	3000V	4000V	1000V	±1, ±5%	39ΚΩ-22ΜΩ	

POWER DERATING CURVE



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RATED VOLTAGE

Resistors should have a Rated Voltage DC or AC corresponding to Rated Power which can be calculated by formula as below.

The Rated Voltage of certain resistance value should be the calculated result or Max. Working Voltage of product series whichever less.

Formula:

 $\begin{aligned} \mathsf{E} &= \mathsf{Rated\ voltage}(\mathsf{V}) \\ \mathsf{E} &= \sqrt{\mathsf{P} \times \mathsf{R}} \end{aligned} \qquad \begin{aligned} \mathsf{P} &= \mathsf{Rated\ power}(\mathsf{W}) \\ \mathsf{R} &= \mathsf{Nominal\ resistance}(\Omega) \end{aligned}$

DIMENSIONS

Unit: mm

Figure	Туре	L	W	Н	А	В
LA,	VR0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.30±0.20
Ţн	VR0805	2.00±0.15	1.25±0.15	0.55±0.10	0.40±0.20	0.40±0.20
L 'B'	VR1206	3.10±0.15	1.55±0.15	0.55±0.10	0.45±0.20	0.45±0.20
	VR1210	3.10±0.10	2.60±0.20	0.55±0.10	0.50±0.25	0.50±0.20
W	VR2010	5.00±0.10	2.50±0.20	0.55±0.10	0.60±0.25	0.50±0.20
	VR2512	6.35±0.10	3.20±0.20	0.55±0.10	0.60±0.25	0.50±0.20

RELIABILITY

Item	Test Method	Acceptable Criterion
Temperature Coefficient of Resistance (T.C.R.)	$TCR(PPM/^{\circ}C) = \frac{(R_2 - R_1)}{R_1 \times (T_2 - T_1)} \times 10^6$ $R_1 = \text{Value in room temperature}$ $R_2 = \text{Value in test temperature} - 55^{\circ}C \text{ or } + 125^{\circ}C$ $T_1 = \text{Room temperature}$ $T_2 = \text{Test temperature} - 55^{\circ}C \text{ or } + 125^{\circ}C$ $Reference: IEC 60115 - 1 6.2$	±100PPM/°C
Insulation Resistance	Using the parallel clamp method: $100\pm15V_{\text{DC}}$ voltage is applied between the electrode and the substrate within 60 seconds. Test the insulation resistance between the terminal and the back of the part. Reference: IEC 60115-1 12.1.3.5	≥ 10 ⁹ Ω
Dielectric Withstanding Voltage	An alternating current with an effective value of the maximum overload voltage is applied between the electrode and the substrate at a rate of approximately 100V/sec. Pressure, maintain 60± 5 sec. The test voltage reference to the DWV in characteristics. Reference: IEC 60115-1 12.2.4	Test to confirm if the presence of current or arc breakdown by ≥10uA
Short Time Over Load	Apply 2.5 times of rated voltage or maximum overload voltage (whichever is the smallest) for 5 seconds Reference: IEC 60115-1 8.1.4.2	1% series: △R/R=±1.0% 5% series: △R/R=±2.0%
Intermittent Overload	Put it in the thermostat, apply 2.5 times of rated voltage, 1 second ON, 25 seconds OFF, 10000^{+400}_{-0} cycles, take it out and stand for 60 minutes, then measure the change rate of resistance value. Reference: IEC 60115-1 8.4.4	△R/R=±5.0%
Resistance to Solvent	Immerse in isopropanol solvent at room temperature (23±5°C) for 5min, wipe 10 times with a hard toothbrush, repeat 3 times, take out and blow dry for examination Reference: IEC 60115-1 11.3.2 method1	No obvious damage, peeling, swelling phenomenon

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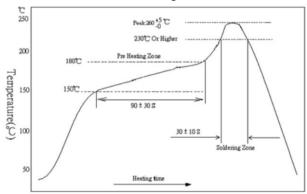
High Voltage Thick Film Chip Resistors Version. C



Version. C					
ltem	Test Method	Acceptable Criterion			
Solderability	Pretreatment: dry heat 155°C, 4 hrs. or PCT aging for 4 hrs. (equivalent), after stand at room temperature for 2 hrs. Test method: 1. Dip the resistance in a tin furnace at 245±3°C for 3 seconds, out and observe the solder area under a microscope; 2. Reflow soldering test, Peak Temperature: 235°C, T=40±5 sec. Reference: IEC 60115-1 11.1.4.3	1. Solder coverage over 95% 2. No welding refusal phenomenon, side soldering height is greater than 1/2 of the height			
Leaching	Pretreatment: dry heat 155° C, 4 hrs. or PCT aging for 4 hrs. (equivalent), after stand at room temperature for 2 hrs. dip in a tin furnace at $260^{+5}_{-0}^{\circ}$ C for 30^{+1}_{-0} seconds, remove and w the area of solder under a microscope Reference: IEC-60068-2-58	No electrode is eroded to expose the			
Resistance to Soldering Heat	The tested resistor be immersed into molten solder of $260^{+5}_{-0}^{\circ}$ C seconds. Then the resistor is left in the room for 1 hr., then mea change rate of resistance value Reference: IEC 60115-1 11.2.4.3				
Thermal Shock	High and low temperature test is carried out according to the u lower limits of the application temperature of the parts, the resi of the upper and lower limits of the temperature is 30min, and temperature conversion time is less than 30s, lasting 500 cycles Reference: IEC 60115-1 10.1.4	dence time the $\triangle R/R=\pm 1.0\%$			
Solder Joint Endurance Test	The SMD resistance was welded to the test board and bent with standard pressure block. After standing for 60 sec. under the condeformation condition, the change rate of resistance value of the tested. Size 0603, 0805 1206, 1210 2000 Depth 5mm 3mm 2mm Reference: IEC 60115-1 9.8.4	orresponding the part was $\Delta R/R = \pm 1.0\%$			
Resistance to Dry Heat	Put it in an oven at $155\pm5^{\circ}$ C for 1000^{+48}_{-0} hrs., take it out and let more than 1hr., then measure the change rate of resistance values Reference: IEC 60115-1 7.3				
Loading Life in Moisture	Place it in a constant temperature and humidity box with 40±2° 90~95%RH and apply the rated voltage with 90 minutes ON and OFF, 1000 hrs. Take it out and stand for 60 minutes, and then mechange rate Reference: IEC 60115-1 10.4	d 30 minutes			
Load Life	Put in an oven at 70±2°C, apply rated voltage, 90 min ON, 30 n hrs., take out and stand for more than 60 min, then measure the change rate. Reference: IEC 60115-1 7.1				
Low temperature load test	-55°C, unpowered, 1 hr.: Rated voltage/current for 45 minutes, unpowered within 15 minutes, return to room temperature, tak stand for 24 hours, then measure the change rate of resistance Reference: IEC 60115-1 10.2.4	e out and 1% series: \triangle R/R=±1.0% value. \triangle R/R=±2.0%			
Shear force test	Weld the part to the PCB. Apply the corresponding test stress from the side of the part with the test terminal for 10s. Check the appearance of the welded end of the part under the stress condition Size 0603 0805 1206, 1210 2010, 2512 Test force 5N 9N 25N 45N Reference: IEC 60115-1 9.7				
Safety test	1.2/50us pulse, 10 consecutive pulses with alternating polarity, each pulse interval 60s, U=2.5KV Reference: IEC-62368 Table D.1 circult2 G.10.3				

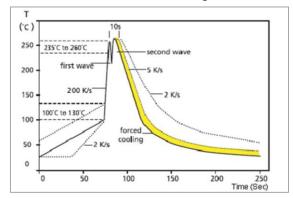
SOLDERING

Lead Free IR Reflow Soldering Profile



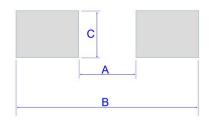
- Top temperature should be under 260 +5/-0 °C ,10Sec.
- Reference: J-STD-020D

Lead Free Double-Wave Soldering Profile



- Suitable for 0603 above size products
- 350±10°C within 3 Sec. if soldering iron.

SOLDERING PAD



Type	А	В	С
VR0603	0.8	2.1	0.9
VR0805	1.2	3.0	1.3
VR1206	2.2	4.2	1.6
VR1210	2.2	4.2	2.8
VR2010	3.5	6.1	2.8
VR2512	3.8	8.0	3.5

WORKING ENVIRONMENT

If user intends to use products in special environments or states (including but not limited to the following), it is necessary to approve special characteristics and reliability for the following or other application environments.

- A. High temperature.
- B. Near the sea, or corrosive gas, such as Cl_2 , H_2S , NH_3 , SO_2 and NO_2 , etc.
- C. Unverified liquids, such as water, oil, chemical or organic solvent.
- D. Unverified resin or paint to cover products.
- E. Products should be washed with water soluble cleaner even if non cleaning flux.

STORAGE / CARRY CONDITIONS

A. Temperature: 25±5°C

B. Humidity: 60±15%RH

C. Storage life: 2 years. FIFO

D. Please hold box correct orientation when storing and carrying. It is strictly prohibited to fall or squeeze the box, otherwise the product electrode or package may be damaged.

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Version. C



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High Voltage Thick Film Chip Resistors Version. C





VERSION HISTORY

Version	Date	Change Item(s)	Description
А	2022/04/22	-	First version
В	2022/10/31	Reliability	Update test items, test method and acceptable criterion.
С	2023/02/18	Characteristics	Update VR1210,2010,2512 MWV, MOV value.
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